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September 26, 2005

Mail Stop Issue Fee  
Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

CUSTOMER NO. 27717

Re: Leadtek Research, Inc.  
Matter No. 405000  
Patent Application for: INTEGRATED PCI INTERFACE  
CARD AND BUS SYSTEM THEREOF  
Application No. 10/607,911

Sir:

Transmitted for filing herewith is the Supplemental Declaration After Allowance. and return postcard.

It is believed that no fee is required. However, if there is a fee, you are authorized to charge same to Deposit Account No. 19-1351.

Sincerely yours,

SEYFARTH SHAW LLP

Harold V. Stotland

HVS:cw  
CH1 10601202.6

CERTIFICATE OF MAILING

I hereby certify that, on 9/26/05, this correspondence is being deposited with the United States Postal Service as first class mail in an envelope addressed to: Mail Stop Issue Fee, Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450.

Carolyn Wilson  
Carolyn Wilson

ATLANTA BOSTON CHICAGO HOUSTON LOS ANGELES NEW YORK SACRAMENTO SAN FRANCISCO WASHINGTON, D.C. BRUSSELS



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re the Application of: Meng-Hsien Liu	)	
Serial No.: 10/607,911	)	<b>CUSTOMER NO.: 27717</b>
Filed: June 27, 2003	)	Group Art Unit: 2111
Title: INTEGRATED PCI INTERFACE CARD AND BUS SYSTEM THEREOF	)	Examiner: DANG, Khanh
Seyfarth Shaw LLP Docket No.: 405000	)	Confirmation No. 8149

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SUPPLEMENTAL DECLARATION AFTER ALLOWANCE

MENG-HSIEN LIU declares that he is the applicant in the above-identified application and is the original, first, and sole inventor of the subject matter which is claimed in the claims as finally allowed in said application; and that he acknowledges the duty to disclose information which is material to the patentability of the claims in said application in accordance with 37 CFR §1.56(a).

The undersigned declares further that all statements made herein of his own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that willful false statements may jeopardize the validity of the application or any patent issuing thereon.

Dated: September 16, 2005

Meng Hsien Liu

CHI 10758109.3